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Deborah W. Wenocur

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Applicant: Chung-Chen Tsao and John Valliant) Grp Art Unit: 3723
Assignee: Credence Systems Corporation) Ex: Shantese McDonald
Serial Number: 10/693,310
Filed: October 24, 2003
For: METHOD AND APPARATUS FOR
BACKSIDE DIE THINNING AND
POLISHING OF PACKAGED
INTEGRATED CIRCUITS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir,

RESPONSE TO OFFICE ACTION

This is in response to the Office Action (Notice of Non-Compliant Amendment) dated January 14, 2005.

The Applicant is re-submitting the claims section of the Office Action response previously sent on December 29, having re-written status identifiers on claims 9, 21, and 22 to comply with the standards.

Respectfully submitted,
Deborah W. Wenocur
Deborah W. Wenocur
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